

Vishay Siliconix

P-Channel 60 V (D-S) 175 °C MOSFET



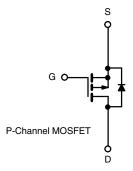
PRODUCT SUMMARY	
V _{DS} (V)	-60
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0069
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5$ V	0.0088
Q _g typ. (nC)	230
I _D (A) ^d	-110

Single

FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ORDERING INFORMATION	
Package	TO-263
Lead (Pb)-free	SUM110P06-07L-E3

ABSOLUTE MAXIMUM RATINGS $(T_C = 2)$	25 °C, unless otherw	rise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	-60	V
Gate-source voltage		V_{GS}	± 20	v
Continuous drain current ^d	T _C = 25 °C		-110	
$(T_J = 175 ^{\circ}C)$	T _C = 125 °C	l _D	-95	A
Pulsed drain current		I _{DM}	-240	
Avalanche current	L = 0.1 mH	I _{AS}	-75	
Single pulse avalanche energy ^a	L = 0.1 mm	E _{AS}	281	mJ
Power dissipation	T _C = 25 °C °C	В	375	W
rower dissipation	T _A = 25 °C b	P _D	3.75	T VV
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	TYPICAL	UNIT
Junction-to-ambient	PCB mount ^b	R_{thJA}	40	°C/W
Junction-to-case		R _{thJC}	0.4	C/VV

Notes

a. Duty cycle ≤ 1 %

Configuration

- b. When mounted on 1" square PCB (FR4 material)
- c. See SOA curve for voltage derating
- d. Limited by package



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60	-	-	
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1	-	-3	V
Gate-body leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
		V _{DS} = -60 V, V _{GS} = 0 V	-	-	-1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V, T _J = 125 °C	-	-	-50	μΑ
		V _{DS} = -60 V, V _{GS} = 0 V, T _J = 175 °C	-	-	-250	,
On-state drain current ^a	I _{D(on)}	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	-120	-	-	Α
		V _{GS} = -10 V, I _D = -30 A	-	0.0055	0.0069	
Duain activos on atata vaciatanas 3		V _{GS} = -10 V, I _D = -30 A, T _J = 125 °C	-	-	0.0115	0
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V, I _D = -30 A, T _J = 175 °C	-	-	0.0138	Ω
		V _{GS} = -4.5 V, I _D = -20 A	-	0.0070	0.0088	,
Forward transconductance ^a	9 _{fs}	V _{DS} = -15 V, I _D = -50 A	20	-	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	11 400	-	
Output capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$	-	1200	-	pF
Reverse transfer capacitance	C _{rss}		-	900	-	,
Total gate charge ^c	Qg		-	230	345	
Gate-source charge ^c	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -110 \text{ A}$	-	50	-	nC
Gate-drain charge ^c	Q_{gd}		-	60	-	,
Gate resistance	R_g	f = 1 MHz	-	3	-	Ω
Turn-on delay time ^c	t _{d(on)}		-	20	30	
Rise time ^c	t _r	V_{DD} = -30 V, R_L = 0.27 Ω	-	53	85	
Turn-off delay time ^c	t _{d(off)}	$I_D\cong$ -110 A, $V_{GEN}=$ -10 V, $R_g=$ 1 Ω	-	110	200	ns
Fall time ^c	t _f		-	220	430	,
Drain-Source Body Diode Characte	ristics (T _C = 25	5 °C b)				
Continuous current	Is		-	-	-110	۸
Pulsed current	I _{SM}		1	-	-240	Α
Forward voltage ^a	V _{SD}	I _F = -85 A, V _{GS} = 0 V	-	-1	-1.5	V
Reverse recovery time	t _{rr}		-	91	137	ns
Peak reverse recovery charge	I _{RM(REC)}	$I_F = -85 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$	-	-6	-9	Α
Reverse recovery charge	Q _{rr}		-	0.21	0.44	μC

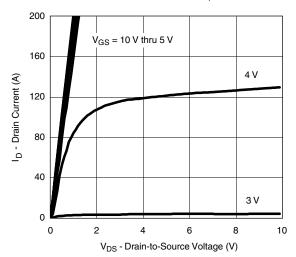
Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

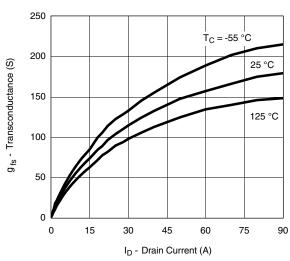
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



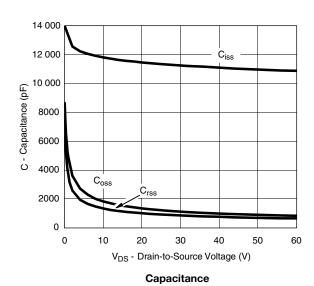
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

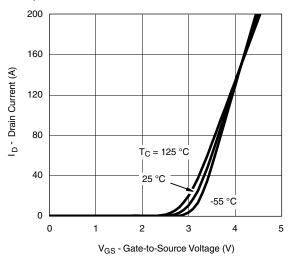


Output Characteristics

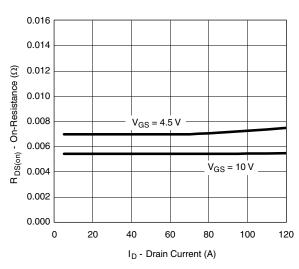


Transconductance

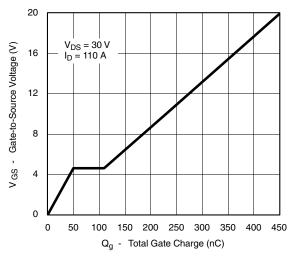




Transfer Characteristics



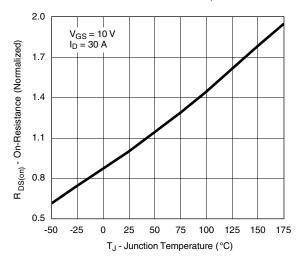
On-Resistance vs. Drain Current



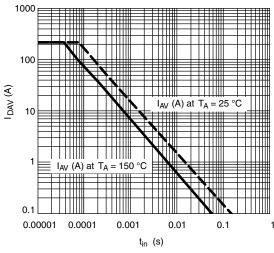
Gate Charge



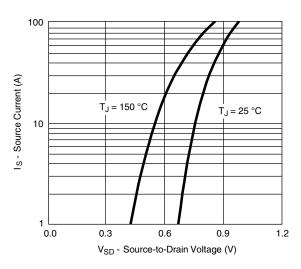
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



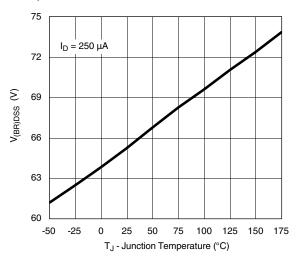
On-Resistance vs. Junction Temperature



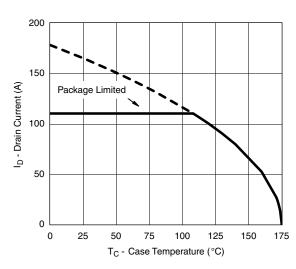
Avalanche Current vs. Time



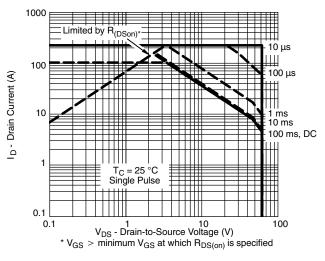
Source-Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature



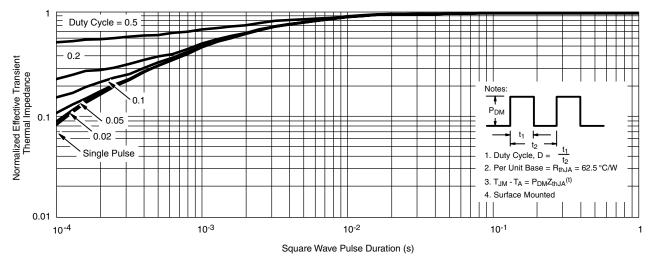
Maximum Avalanche and Drain Current vs. Case Temperature



Safe Operating Area



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

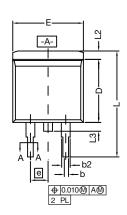
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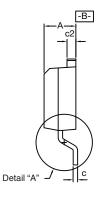
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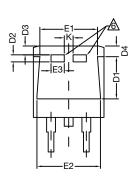


TO-263 (D²PAK): 3-LEAD

VERSION 1: FACILITY CODE = T

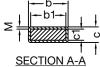








DETAIL A (ROTATED 90°)



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< T		[C]	ပ
SF	CTION	1	1

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

		INC	HES	MILLIMETERS		
	DIM.	MIN.	MAX.	MIN.	MAX.	
Α		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
١	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
Ü	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	Е	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54	BSC	
	K	0.045	0.055	1.143 1.397		
	L	0.575	0.625	14.605	15.875	
	L1	0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010	BSC	0.254	BSC	
	М	-	0.002	-	0.050	

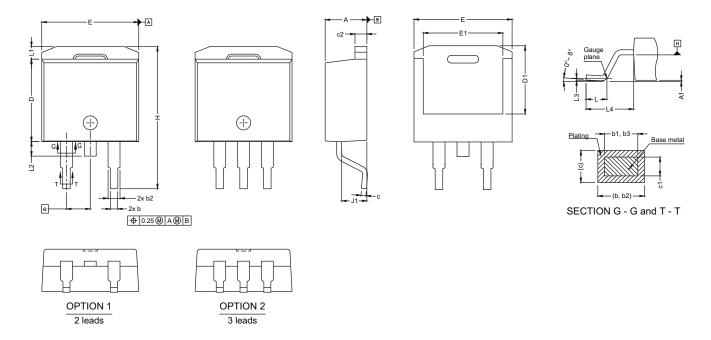
Revison: 28-Oct-2024 Document Number: 71198



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VERSION 2: FACILITY CODE = N



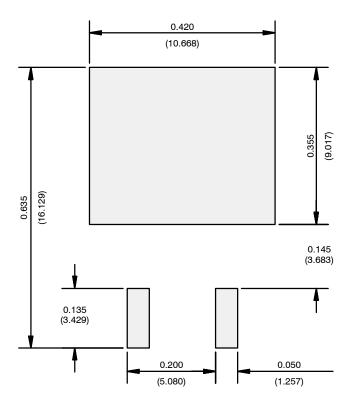
DIM.	MIN.	MAX.
A	4.36	4.56
A1	0	0.25
b	0.70	0.90
b1	0.51	0.89
b2	1.20	1.46
b3	1.17	1.37
С	0.38	0.694
c1	0.38	0.534
c2	1.19	1.34
D	8.60	9.00
D1	6.9	7.5
E	10.15	10.55
E1	8.1	8.7
е	2.54	BSC
Н	15.0	15.6
L	1.9	2.5
L1	-	1.65
L2	-	1.78
L3	0.25	5 typ.
L4	4.78	5.28
J1	2.56	2.96

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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